

PRODUCT SPECIFICATION

Part No.:	AC-SP-MG25-10	
Description:	25G SFP28 Transceiver, MWDW 10km	
Release Date	Rev.	Revision Change Description
2019/06/07	A0	New Release
2020/12/28	A1	Template Update

Features

- ✧ Supports 25Gbps data rate
- ✧ DFB laser-TEC and PIN photo-detector
- ✧ DFB laser-TEC and APD receiver
- ✧ Duplex LC receptacle optical interface compliant
- ✧ Single +3.3V power supply
- ✧ Power dissipation < 1.8W
- ✧ Hot-pluggable SFP28 form factor
- ✧ Internal CDR on both Transmitter and Receiver channel
- ✧ Maximum link length of 10km
- ✧ Operating temperature range:
 - ✧ Commercial: 0°C~+70°C (PIN)
 - ✧ Industrial: -40°C~+85°C (APD)
- ✧ RoHS Compliant
- ✧ Digital diagnostics functions are available via the I2C interface

Application

- ✧ 25GBASE-LR Ethernet
- ✧ CPRI 10

Standard

- ✧ Compliant to SFF-8431
- ✧ Compliant to SFF 8472
- ✧ Compliant to IEEE 802.3 CC
- ✧ RoHS Compliant.

Specification

Absolute Maximum Ratings					
Parameter	Symbol	Min	Max	Unit	
Storage temperature	TS	-40	85	°C	
Power Supply Voltage	Vcc	0	3.6	V	
Relative Humidity	RH	5	95	%	
Recommended Operating Conditions					
Parameter	Symbol	Min	Typical	Max	Unit
Operating Case Temperature (Commercial)	Tc	0		70	°C
Power Supply Voltage	Vcc	3.13	3.3	3.47	V
Supply Current	Icc			450	mA
Data Rate		-	25.78	-	Gbps

Optical transmitter Characteristics						
Parameter	Symbol	Min	Typical	Max	Unit	Notes
Launched Power (avg.)	Pout	0		5	dBm	
Operating Wavelength Range	λc-1	1265	1267.5	1270	nm	
	λc-2	1272	1274.5	1277	nm	
	λc-3	1285	1287.5	1290	nm	
	λc-4	1292	1294.5	1297	nm	
	λc-5	1305	1307.5	1310	nm	
	λc-6	1312	1314.5	1317	nm	
	λc-7	1325	1327.5	1330	nm	
	λc-8	1332	1334.5	1337	nm	
	λc-9	1345	1347.5	1350	nm	
	λc-10	1352	1354.5	1357	nm	
	λc-11	1365	1367.5	1370	nm	
	λc-12	1372	1374.5	1377	nm	
Spectral Width (-20dB)	σ			1	nm	
Extinction Ratio	ER	4			dB	
Side Mode Suppression Ratio	SMSR	30			dB	
Differential data input swing	VIN,PP	180		700	mV	
Input Differential Impedance	ZIN	90	100	110	Ω	
TX Disable	Disable		2.0	Vcc	V	
	Enable		0	0.8	V	
TX Fault	Fault		2.0	Vcc	V	
	Normal		0	0.8	V	

Output Eye Diagram	Complies with IEEE802.3z eye masks when filtered					
Optical receiver Characteristics						
Parameter	Symbol	Min	Typical	Max	Unit	Notes
Receiver Sensitivity	S			-10.6	dBm	PIN
Receiver Sensitivity	S			-18.5	dBm	APD
Optical Overload		-3	-		dBm	
Wavelength Range	λ_c	1260		1610	nm	
LOS	Optical De-assert	Pd		-12.5	dBm	
	Optical Assert	Pa		-13.5		
LOS	High	2.0		Vcc	V	
	Low			0.8	V	
LOS hysteresis		0.5			dB	
Differential data output swing	Vout,PP	300		900	mV	

Timing and Electrical					
Parameter	Symbol	Min	Max	Unit	Conditions
Tx-Disable assert time	T_off		100	us	Rising edge of Tx_Disable to fall of output signal below 10% of nominal
Tx-Disable negate time	T_on		2	ms	Falling edge of Tx_Disable to rise of output signal above 90% of nominal,this is only applies in normal operation,ont during start up or fault recovery.
Time to initialize 2-wire interface	t_2w_start_up		300	ms	From power on or hot plug after the supply meeting
Time to initialize	T_start_up		300	ms	From power supplies meeting hot plug or Tx disable negated during power up ,or Tx_Fault recovery,until non-cooled power level I part is full operational
Time to initialize cooled module and time to power up a cooled module to power level II	T_start_up_cooled		90	S	From power supplies meeting hot plug or Tx disable negated during power up ,or Tx_Fault recovery,until non-cooled power level I part is full operational.Also,from stoop bit low-to-high SDA transition enabling Power Level II until cooled module is fully operational.
Time to Power up to level II	T_power_level_2		300	ms	From stop bit low-to-high SDA transition enabling power Level II until non-cooled module is fully operational.
Time to Power Down from level II	T_power_down		300	ms	From stop bit low-to-high SDA transition disabling power level II until module is within power level I requirements.
Tx_Fault assert	Tx_Fault_on		1	ms	From occurrence of fault to assertion of Tx_Fault.
Tx_Fault assert for cooled module	Tx_Fault_on_cooled		50	ms	From occurrence of fault to assertion of Tx_Fault.
Tx_Fault Reset	T_reset	10		us	Time Tx_Disable must be held high to reset Tx_Fault.

RSO,RSI rate select timing for FC	T_RSO_FC,T_RSI_FC		500	us	From assertion till stable output
RSO,RSI rate select timing non FC	T_RSO,T_RSI		24	ms	From assertion till stable output
Rx_LOS assert delay	T_los_on		100	us	From occurrence of loss of signal to assertion of Rx_LOS
Rx_LOS assert delay	T_los_off		100	us	From occurrence of loss of signal to negation of Rx_LOS

Digital Diagnostic Monitoring Information

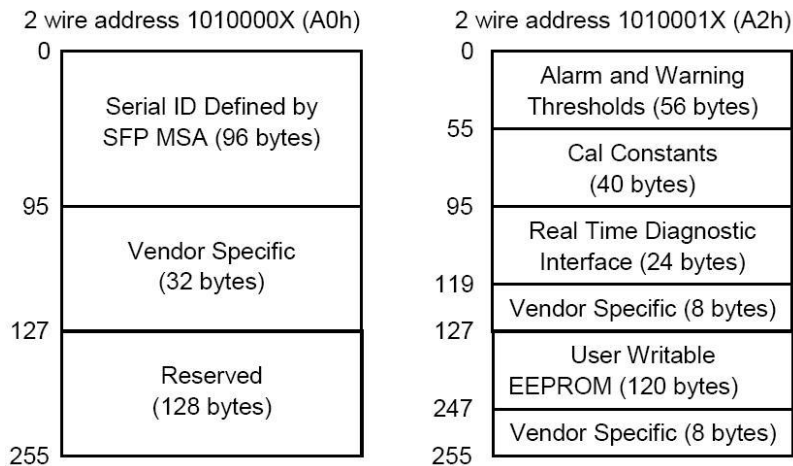
Parameter	Accuracy	Calibration	Range
Temperature	±3°C	internal/ External	0~70°C
Voltage	±3%	internal/ External	3.0 to 3.6 V
Bias Current	±10%	internal/ External	0 to 100 mA
TX Power	±3dB	internal/ External	0 to 5 dBm
RX Power	±3dB	internal/ External	-10.6 to 0 dBm

Digital Diagnostic Memory Map

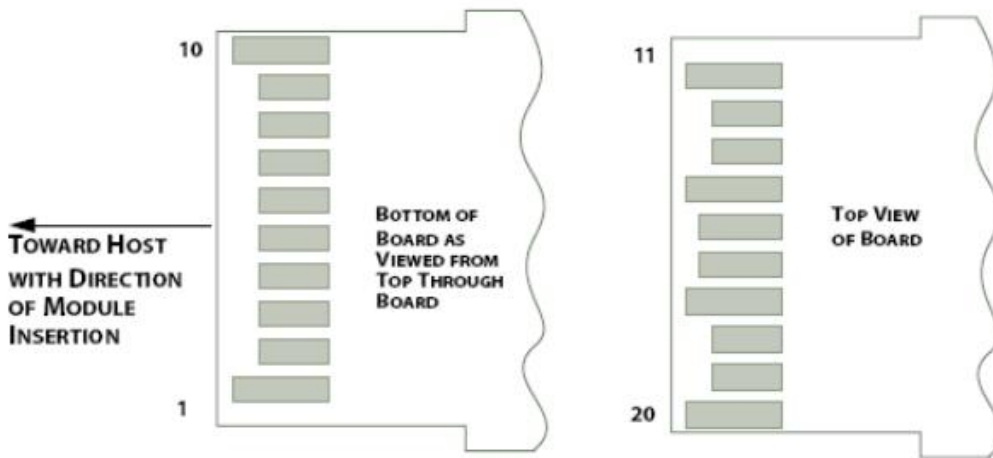
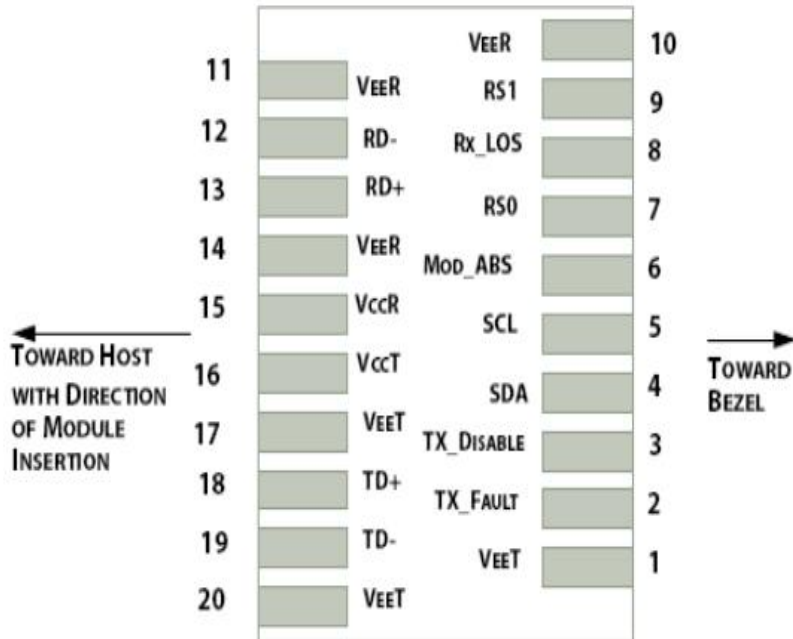
The transceivers provide serial ID memory contents and diagnostic information about the present operating conditions by the 2-wire serial interface (SCL, SDA).

The diagnostic information with internal calibration or external calibration all are implemented, including received power monitoring, transmitted power monitoring, bias current monitoring, supply voltage monitoring and temperature monitoring.

The digital diagnostic memory map specific data field defines as following.



Pin Descriptions



Pin	Name	Function/Description	Logic	Note
1	VeeT	Transmitter Ground		1
2	TX_Fault	Transmitter Fault	LVTTTL-O	2
3	TX_Disable	Transmitter Disable. High: Transmitter off; Low: Transmitter on	LVTTTL-I	
4	SDA	2-Wire Serial Interface Data Line	LVTTTL-O/I	2
5	SCL	2-Wire Serial Interface Clock	LVTTTL-I	2
6	Mod_ABS	Module Absent, Connect to VeeT or VeeR in Module		
7	RS0	Rate Select 0, optionally controls SFP module receiver	LVTTTL-I	

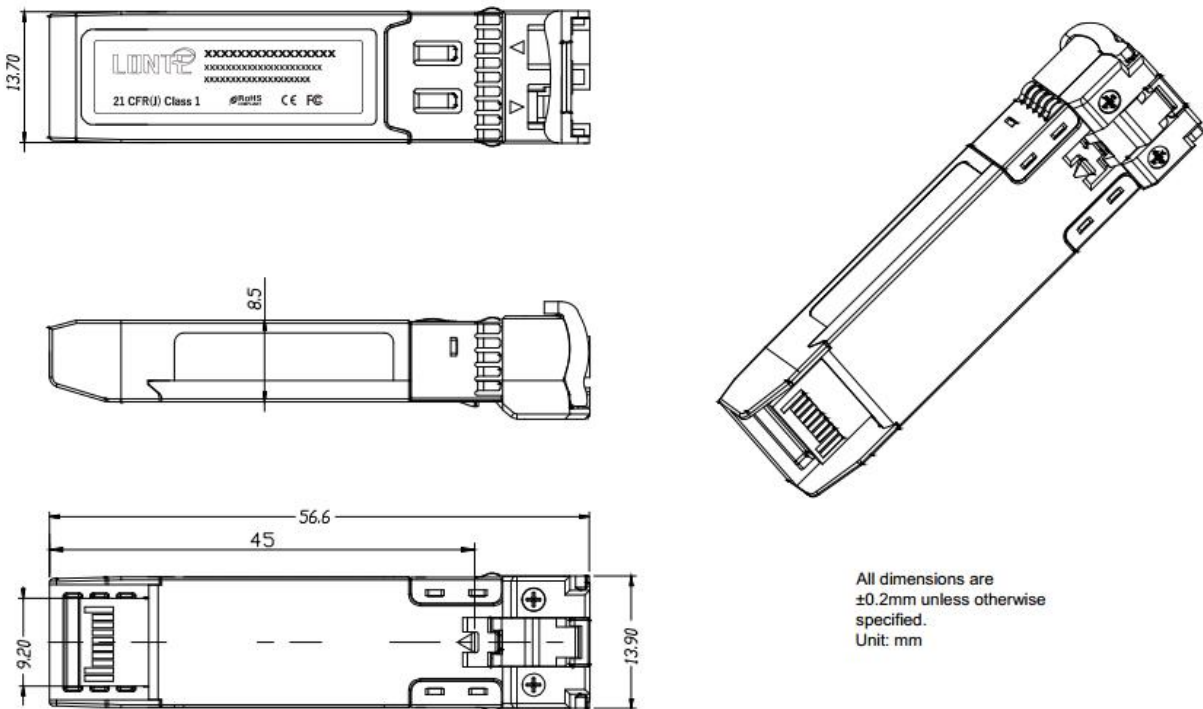
8	RX_LOS	Receiver Loss of Signal indication. High: loss of signal; Low: signal detected	LVTTTL-O	
9	RS1	Rate Select 1, optionally controls SFP module transmitter	LVTTTL-I	
10	VeeR	Receiver Ground		1
11	VeeR	Receiver Ground		1
12	RD-	Receiver Inverted Data Output	CML-O	
13	RD+	Receiver Data Output	CML-O	
14	VeeR	Module Receiver Ground		1
15	VccR	Receiver Power 3.3V Supply		
16	VccT	Transmitter Power 3.3V Supply		
17	VeeT	Module Transmitter Ground		1
18	TD+	Transmitter Non-Inverted Data Input	CML-I	
19	TD-	Transmitter Inverted Data Input	CML-I	
20	VeeT	Module Transmitter Ground		1

Notes:

- 1) Module ground pins GND are isolated from the module case.
- 2) Shall be pulled up with 4.7K-10Kohms to a voltage between 3.15V and 3.45V on the host board.

Package Outline

Dimensions are in millimeters. All dimensions are $\pm 0.2\text{mm}$ unless otherwise specified. (Unit: mm)



Regulatory Compliance

Feature	Test	Method
Electrostatic Discharge (ESD) to the Electrical Pins	MIL-STD-883E Method 3015.7	Class 1 (>1.5kV) – Human Body Model
Electrostatic Discharge (ESD) Immunity	IEC61000-4-2	Class 2(>4.0kV)
Electromagnetic Interference (EMI)	CISPR22 ITE Class B FCC Class B CENELEC EN55022 VCCI Class 1	Comply with standard
Immunity	IEC61000-4-3	Comply with standard
Eye Safety	FDA 21CFR 1040.10 and 1040.11 EN (IEC) 60825-1,2	Compatible with Class I laser Product

Ordering information

Part. No	Specifications								
	Pack	Rate (Gbps)	Tx (nm)	Po (dBm)	RX	Sen (dBm)	Temp (°C)	Reach (km)	DDM
AC-SP-MG25-10	SFP28	25.78	MWDM	0~5	PIN	<-10.6	0~70	10	Y
AC-SP-MG25-10	SFP28	25.78	MWDM	0~5	APD	<-18.5	-40~85	10	Y